Datasheet	Created Date	Document No.	Document Retention	Security		Author
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Datasheet

CMX09Q03

Rev. 1.2

Release Date 2021-07-14

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3dB, 90°, Hybrid Coupler
with High-Power Capacity and Stable Performance based on RN2 LTCC Multilayer Technology
Model Name: CMX09Q03

KEY FEATURES

- Excellent high-power capacity up to average 200 watts
- Excellent stable performance at different temperatures
- Low insertion loss based on a LTCC base (Er = 5.95), high conductivity metal conductor (Ag), and gold (Au) plating
- Surface mount type
- RoHS compliance (Pb-Free)

APPLICATIONS

- Applications using GSM, UMTS, and LTE
- RF amplifiers
- Communications equipment

GENERAL DESCRIPTIONS

The CMX09Q03 is a 3dB, 90° hybrid coupler with high-power capacity and stable performance in different temperatures. The LTCC, high conductivity metal conductor (Ag), and gold (Au) plating enable the CMX09Q03 to minimize insertion loss and improve durability for thermal stabilization and electricity.

The CMX09Q03 is suited for applications using GSM, UMTS, LTE and communications equipment, requiring low insertion loss and high power.

The CMX09Q03 supports up to average 200 watts. It is a SMD type product enabling Pb-Free solder and meets RoHS-6.

ELECTRICAL SPECIFICATIONS

Frequency (MHz)	Amplitude Balance Max.(dB)	Insertion Loss Max.(dB)	Return Loss Min.(dB)
700 - 800	± 0.40	0.14	23
800 - 1000	± 0.30	0.14	23
869 - 894	± 0.20	0.12	25
925 - 960	± 0.25	0.12	25
Isolation Min.(dB)	**Phase Balance (Degree)**	**Power Capacity Avg.(Watt)**	**Operating Temperature(℃)**
23	90 ± 3.0	200	-55 ~ 125
23	90 ± 3.0		
25	90 ± 2.0		
25	90 ± 3.0		

NOTE: These electrical specifications are measured by using a RN2 test board.
Specifications subject to change without notice.

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Contents

KEY FEATURES **2**
APPLICATIONS **2**
GENERAL DESCRIPTIONS **2**
ELECTRICAL SPECIFICATIONS **2**
PORT CONFIGURATIONS **4**
MECHANICAL SPECIFICATIONS **4**
POWER DERATING CURVE **5**
RF PERFORMANCE CURVES: Return Loss (-55 ºC, 25 ºC, and 125 ºC) **6**
RF PERFORMANCE CURVES: Amplitude Balance, Insertion Loss, Isolation, and Phase Balance (-55 ºC, 25 ºC, and 125 ºC) **7**
RF TEST METHODS **8**
RF TEST PROCEDURES 8
RN2 TEST BOARD LAYOUT 11
AUTOMATIC PORT EXTENSIONS (APE) FUNCTION 11
RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN **12**
SOLDERING PROCESS **13**
REFLOW PROFILE **14**
PACKAGING AND ORDERING INFORMATION **15**
CAUTION **16**
LEGAL INFORMATION **17**

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PORT CONFIGURATIONS

Figure 1 shows the locations of the CMX09Q03 ports. The orientation marker is included to represent port 1.

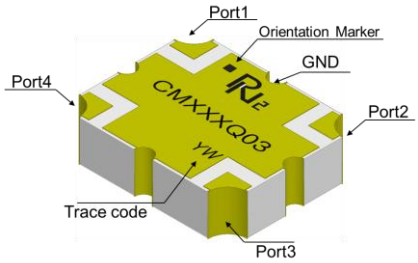


Figure 1. CMX09Q03 (Top View)

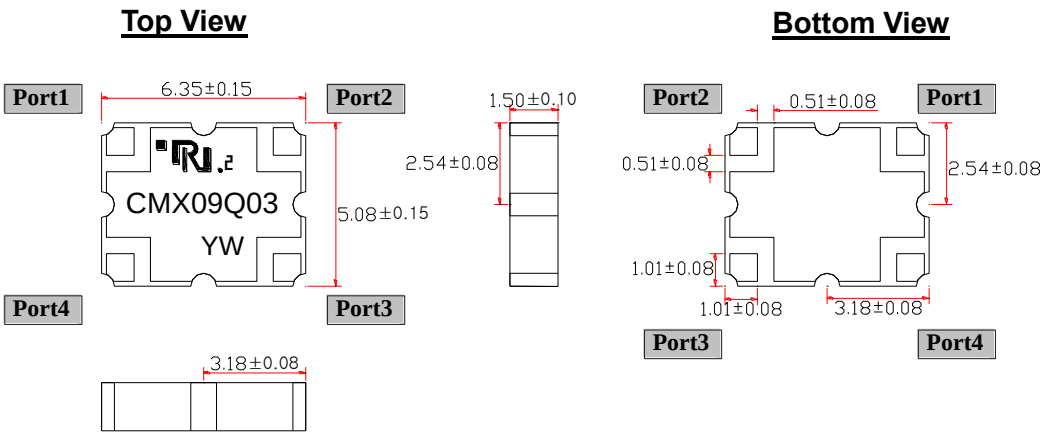
Table 1 describes the CMX09Q03 port configurations depending on how input signals are split. The Case 1, Case 2, Case 3, and Case 4 configurations mean that one input signal is split into two output signals. When port 1 is defined, the other ports are defined automatically.

Table 1. CMX09Q03 Port Configurations

Configuration	Port 1	Port 2	Port 3	Port 4
Case 1.	Input	Isolated	Output -3dB, -90˚	Coupling -3dB, *0˚
Case 2.	Isolated	Input	Coupling -3dB, *0˚	Output -3dB, -90˚
Case 3.	Output -3dB, -90˚	Coupling -3dB, *0˚	Input	Isolated
Case 4.	Coupling -3dB, *0˚	Output -3dB, -90˚	Isolated	Input

***NOTE**: 0˚ is an actual phase or amplitude of the frequency specified at all ports.

MECHANICAL SPECIFICATIONS



- Unit: mm
- Weight: 0.14 grams
- Camber specifications: Less than 0.08 mm

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POWER DERATING CURVE

Figure 2 shows the maximum allowable average power (Maximum input power, CW) of the CMX09Q03 depending on base PCB temperature changes. The maximum allowable average power of the CMX09Q03 is limited by the following power derating curve.

The CMX09Q03 factors that determine the power derating curve are as follows:

- Internal circuit
- Thickness
- Thermal conductivity of materials
- Insertion loss
- Operating temperature
- Mounting interface temperature between the CMX09Q03 and the base PCB

The maximum operating temperature of the CMX09Q03 is 125 ºC. Therefore, when the base PCB temperature is over 125 ºC, the CMX09Q03 operates stably by decreasing its durable average input power. When the base PCB temperature reaches 200 ºC, the maximum allowable average power decreases to 0 watt.

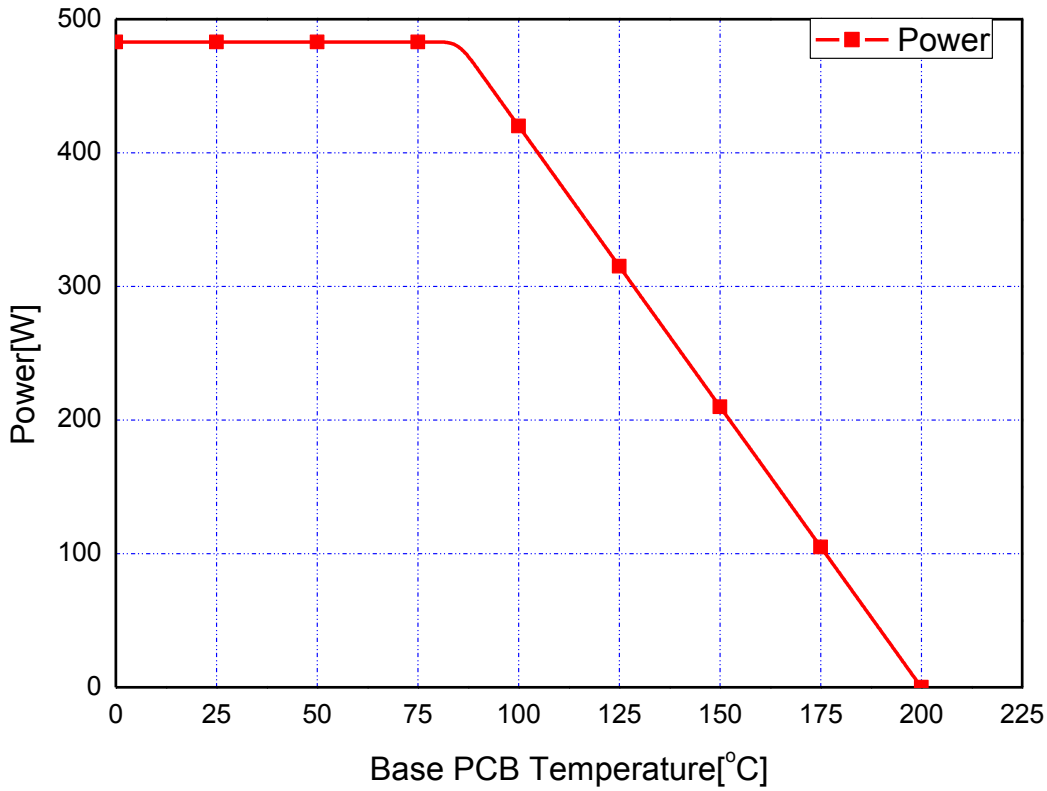

Figure 2. Power Derating Curve

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RF PERFORMANCE CURVES: Return Loss (-55 ºC, 25 ºC, and 125 ºC)

Figure 3 shows the test plots of the return loss for the CMX09Q03. There are few variations for the specified frequencies and temperatures.

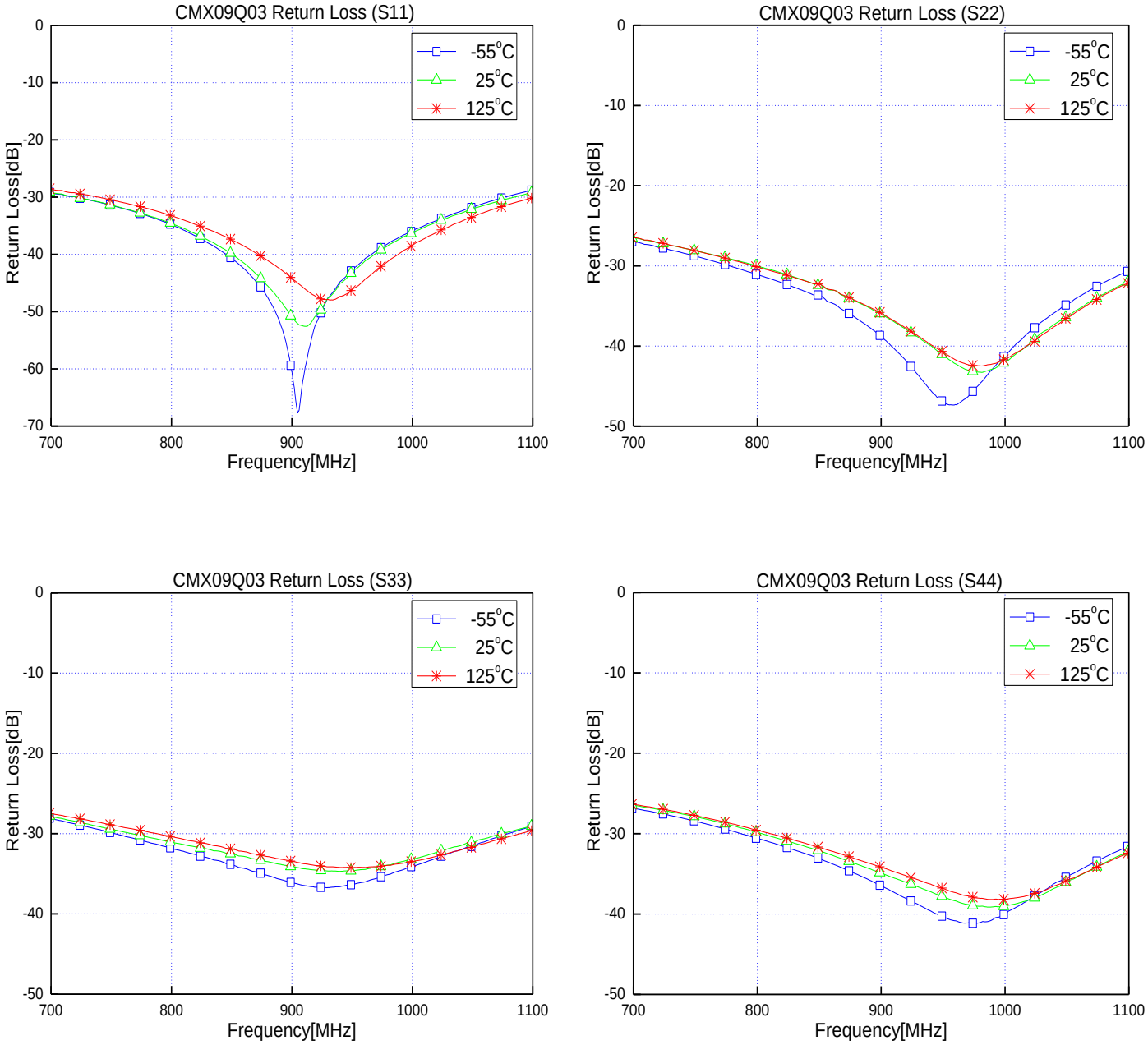

Figure 3. Test Plots of Return Loss (-55 ºC, 25 ºC, and 125 ºC)

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RF PERFORMANCE CURVES: Amplitude Balance, Insertion Loss, Isolation, and Phase Balance (-55 ºC, 25 ºC, and 125 ºC)

Figure 4 shows the test plots of the coupling and transmission loss, insertion loss, isolation and phase balance for the CMX09Q03. There are few variations for the specified frequencies and temperatures. These test plots result from the Case 1 configuration in *'Table 1. CMX09Q03 Port Configurations'*. See *'PORT CONFIGURATIONS'* for more details.

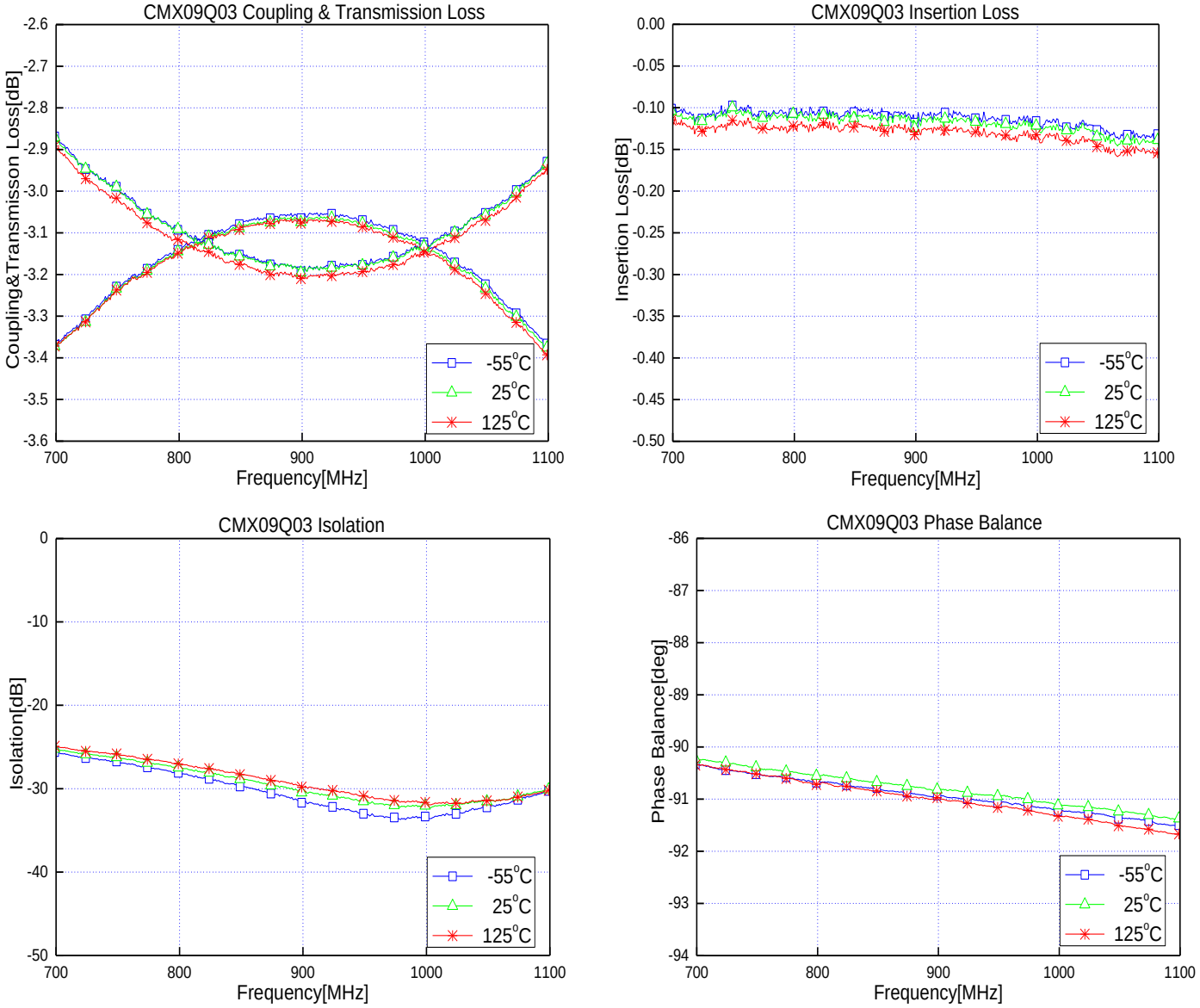

Figure 4. Test Plots of Amplitude Balance, Insertion Loss, Isolation and Phase Balance (-55 ºC, 25 ºC, and 125 ºC)

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RF TEST METHODS

This section describes how to test the CMX09Q03 RF performance. To ensure s-parameters reliability, we follow our internal test procedures by using the RN2 bare test board, RN2 test board, Vector network analyzer, and test fixture. In addition, we use the Automatic Port Extensions (APE) function of the Vector network analyzer to obtain accurate s-parameters.

Check the following sections for more details:

- RF TEST PROCEDURES
- RN2 TEST BOARD LAYOUT
- AUTOMATIC PORT EXTENSIONS (APE) FUNCTION

RF TEST PROCEDURES

To test the CMX09Q03 RF performance, we perform the following steps:

1. Preparing the Test Equipment
2. Performing the Automatic Port Extensions (APE) Function of the Vector Network Analyzer
3. Measuring the S-parameters (Coupling, Transmission Loss, Isolation, and Return Loss)
4. Obtaining the Characteristic Parameters (Amplitude Balance, Isolation, Insertion Loss, Return Loss, and Phase Balance)

STEP 1: Preparing the Test Equipment

The following test equipment is prepared to test the CMX09Q03 RF performance.

- RN2 bare test board
- RN2 test board
- Vector network analyzer
- Test fixture

NOTE: See *'RN2 TEST BOARD LAYOUT'* for the RN2 test board details.

STEP 2: Performing the Automatic Port Extensions (APE) Function of the Vector Network Analyzer

The APE function is used with the RN2 bare test board to correctly check the CMX09Q03 RF performance. This reduces or eliminates both electrical delay and insertion loss of the test fixture.

The detailed steps are as follows:

1. Place the RN2 bare test board on the test fixture.
2. Click the **Cal** button of the Vector network analyzer to calibrate it.
3. Connect the four ports of the test fixture into the four ports of the Vector network analyzer.
4. Click the **Port Extensions** button of the Vector network analyzer to measure the data of the RN2 bare test board.

NOTE: See *'AUTOMATIC PORT EXTENSIONS FUNCTION'* for more details.

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STEP 3: Measuring the S-parameters (Coupling, Transmission Loss, Isolation, and Return Loss)

After performing the APE function, the CMX09Q03 s-parameters are measured through the following steps:

1. Place the RN2 test board on the test fixture.
2. Apply pressure to the test fixture using a pneumatic piston.
3. Connect the four ports of the test fixture into the four ports of the Vector network analyzer.
4. Set port1 as Case 1 configuration in *'Table 1. CMX09Q03 Port Configurations'*.
5. Calibrate the Vector network analyzer.
6. Measure the coupling value from port 1 to port 4 (S41).
7. Measure the transmission loss value from port 1 to port 3 (S31).
8. Measure the isolation value from port 1 to port 2 (S21).
9. Measure the return loss value from port 1 to port 1, port 2 to port 2, port 3 to port 3, and port 4 to port 4 respectively (S11, S22, S33, and S44).

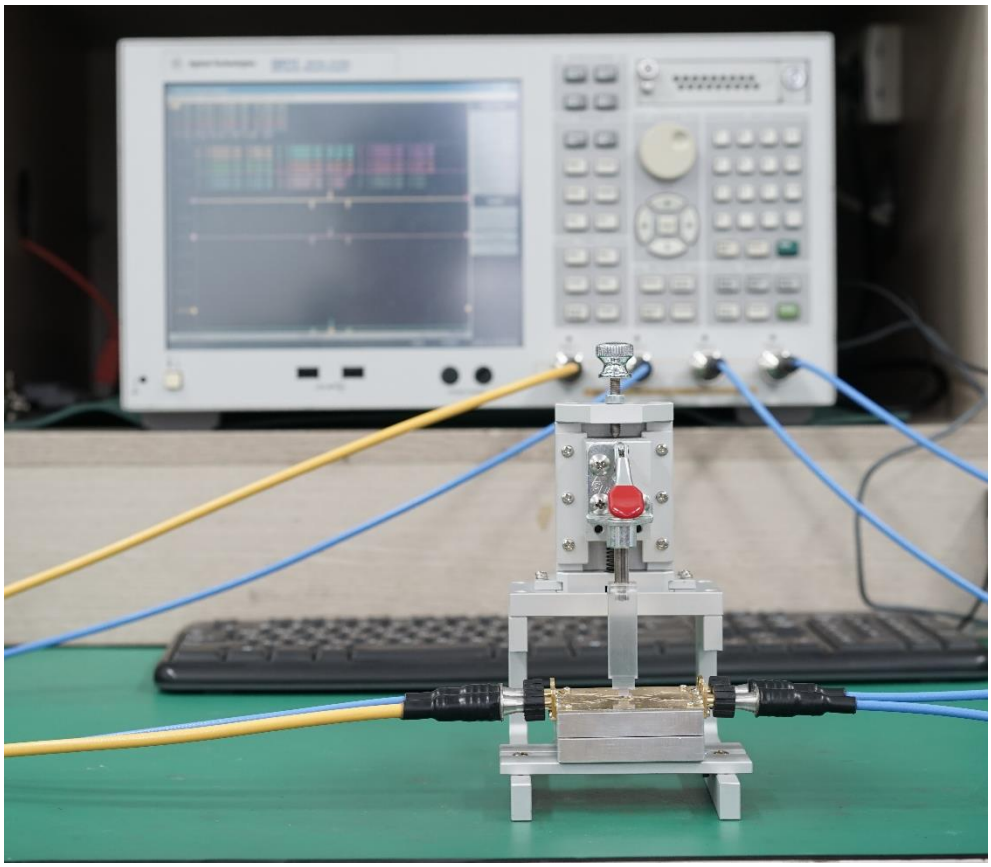

Figure 5. Test Setting to Measure the CMX09Q03 S-parameters

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STEP 4: Obtaining the Characteristic Parameters (Amplitude Balance, Isolation, Insertion Loss, Return Loss, and Phase Balance)

The s-parameters are calculated by using the formula in ***Table 2*** to obtain the characteristic parameters, such as amplitude balance, isolation, insertion loss, return loss, and phase balance.

Table 2. Mathematical Formula for the CMX09Q03 Parameters

Parameter	S-Parameter	Power Method
Coupling	S41	$10 \cdot \log\left(\frac{P_{cou}}{P_{in}}\right)$
Transmission Loss	S31	$10 \cdot \log\left(\frac{P_{out}}{P_{in}}\right)$
Isolation	S21	$10 \cdot \log\left(\frac{P_{iso}}{P_{in}}\right)$
Insertion Loss	-	$10 \cdot \log\left(\frac{P_{in}}{P_{cou} + P_{out}}\right)$
Return Loss	S11 S22 S33 S44	$10 \cdot \log\left(\frac{P_{in}}{P_{back}}\right)$
Amplitude Balance	-	$10 \cdot \log\left(P_{cou} \Big/ \frac{P_{cou} + P_{out}}{2}\right)$
Phase Balance	S41 S31	$\text{Phase}_{(S41)} - \text{Phase}_{(S31)}$

NOTE

- P_{in} : Power of Input Port
- P_{out} : Power of Output Port
- P_{cou} : Power of Coupling Port
- P_{iso} : Power of Isolated Port
- P_{back} : Return Power of Input Port

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RN2 TEST BOARD LAYOUT

Figure 6 shows the RN2 test board layout used for testing the CMX09Q03 RF performance. The RN2 test board is based on the Taconic RF35 board with the dielectric constant of 3.5, board thickness of 0.8 mm, and copper of 1 Oz.

We recommend that you use the same material and design layout, as shown in ***Figure 6***, to meet the specifications in this datasheet. However, if you use different materials, you must follow the basic guidelines. See *'RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN'* for more details.

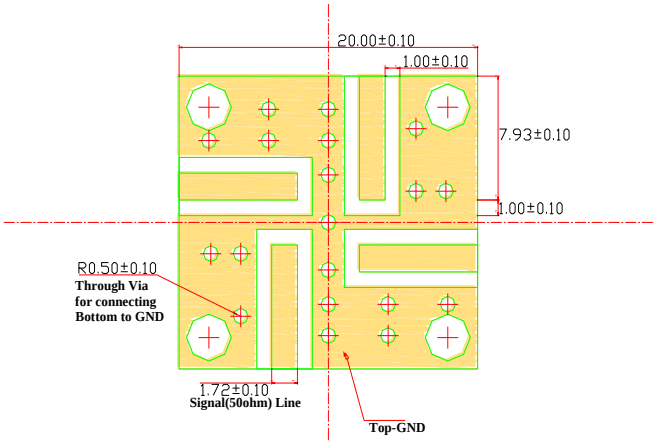

Figure 6. RN2 Test Board Layout

AUTOMATIC PORT EXTENSIONS (APE) FUNCTION

To accurately measure the CMX09Q03 s-parameters, we use the Automatic Port Extensions (APE) function of the Vector network analyzer. The APE function is used for reducing or eliminating both electrical delay and insertion loss of test fixtures. It provides a convenient, automated way to calculate the insertion loss and electrical delay terms by a simple measurement of an open or short circuit, which is easy to do in test fixtures.

We consider the transmission lines of the RN2 bare test board as extensions of the coaxial test cables that are between the Vector network analyzer and the CMX09Q03. With the APE function, we extend the coaxial test ports so that our calibration plane is right at the terminals of the CMX09Q03, and not at the connectors of the RN2 bare test board.

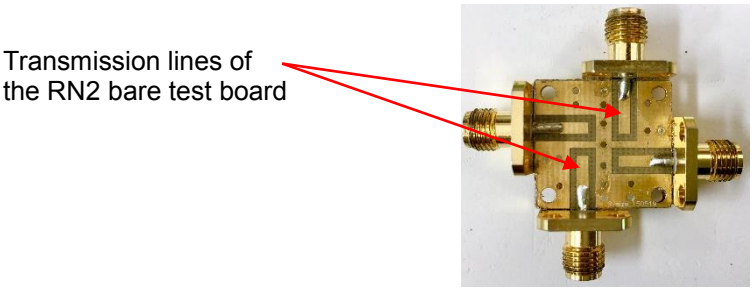

Figure 7. Performing the APE Function Test

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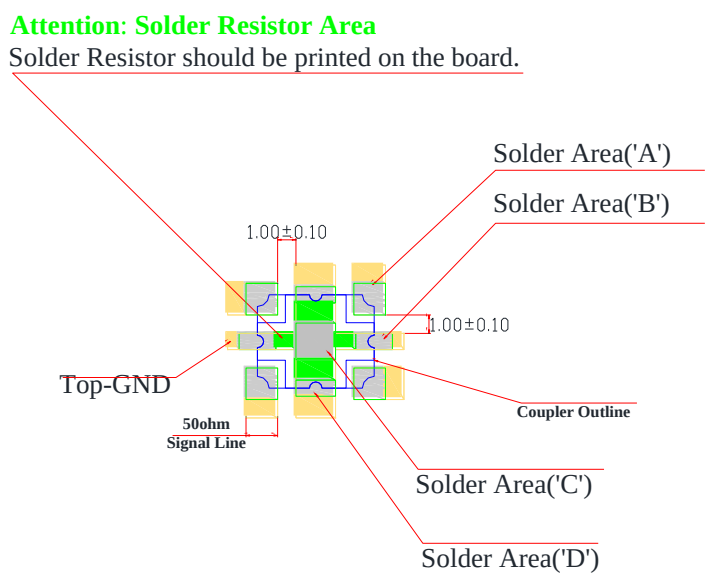
RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN

Figure 8 shows the recommended PCB layout and solder mask pattern to meet the specifications in this datasheet. When you use different materials other than the RN2 test board, you must follow the basic guide lines at minimum.

Basic Guidelines

- Place GND more than 30% of the CMX09Q03 GND dimension regardless of a via size.
- Appropriately increase via sizes and numbers to allow low impedance ground connection and good thermal conductivity.
- Align the CMX09Q03 ground plane with the solder to have good connection to ground.
- Fill the via holes under the CMX09Q03 with the solder for thermal emission.

NOTE: Contact the RN2 Technologies sales team for more detailed PCB layout and solder mask pattern information.



NOTE

- Test Solder Cream: SAC-305 (Alpha Metal)
- Pb-Free Solder Alloy: Sn/Ag/Cu Ratio of 96.5/3.0/0.5
- Solder Area ('A') Dimension : 1.72 by 1.72
- Solder Area ('B') Dimension : 2.00 by 0.88
- Solder Area ('C') Dimension : 2.15 by 2.00
- Solder Area ('D') Dimension : 2.15 by 0.88
- Unit: mm

Figure 8. Recommended PCB Layout and Solder Mask Pattern

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SOLDERING PROCESS

The CMX09Q03 soldering steps are as follows:

1. Cleaning the PCB
2. Applying solder paste to the PCB
3. Placing the CMX09Q03 on the PCB
4. Reflowing the CMX09Q03 to the PCB
5. Cleaning and inspecting the soldered PCB with the CMX09Q03

STEP 1: Cleaning the PCB
Carefully clean the PCB surface where the CMX09Q03 is soldered.
Particles must not be placed on the PCB surface where the CMX09Q03 is soldered.

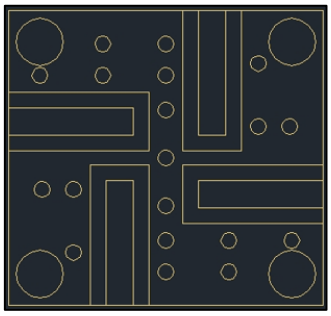

Figure 9. Cleaning the PCB Surface Where the CMX09Q03 is Soldered

STEP 2: Applying the Solder Paste to the PCB
Apply the solder paste to the 9 points on the PCB surface.
It enables good thermal conductivity because the CMX09Q03 is firmly attached to the PCB surface without air.

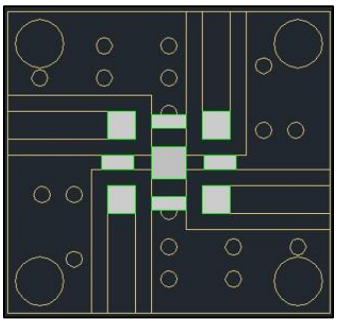

Figure 10. Applying the Solder Paste to the 9 Points on the PCB Surface

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STEP 3: Placing the CMX09Q03 on the PCB
Correctly place the CMX09Q03 on the 9 points of the PCB surface.
Applying the solder paste to the 9 points helps you firmly attach the CMX09Q03 to the PCB surface.

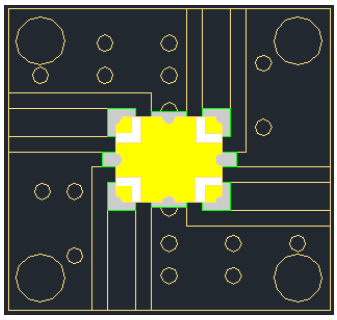

Figure 11. Placing the CMX09Q03 on the 9 Points of the PCB Surface

STEP 4: Reflowing the CMX09Q03 to the PCB
We recommend both manual soldering and PCB surface pre-heating methods when reflowing the CMX09Q03 to the PCB surface. Be careful NOT to touch the iron tip to the CMX09Q03 when you use the manual soldering method.
See *'REFLOW PROFILE'* for more details.

REFLOW PROFILE

Figure 12 shows the thermal reflow profile of the SAC-305 (Alpha metal), which is a test solder cream we used.

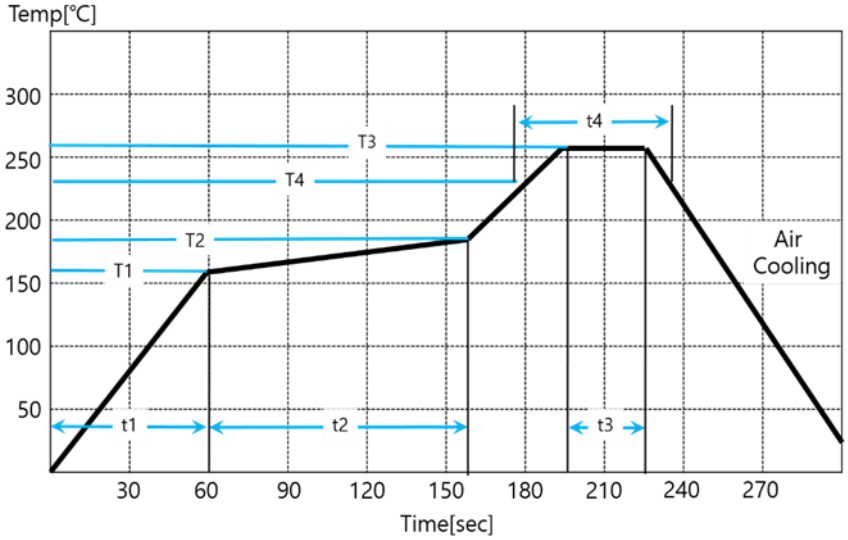

Figure 12. Thermal Reflow Profile

	Ramp Up	Pre-Heating	Peak	Soaking
Temperature(℃)	T1:160±5	T2:180±5	T3:260±5	T4:230±5
Time(sec)	t1:60±5	t2:100±15	t3:30±5	t4:60±10

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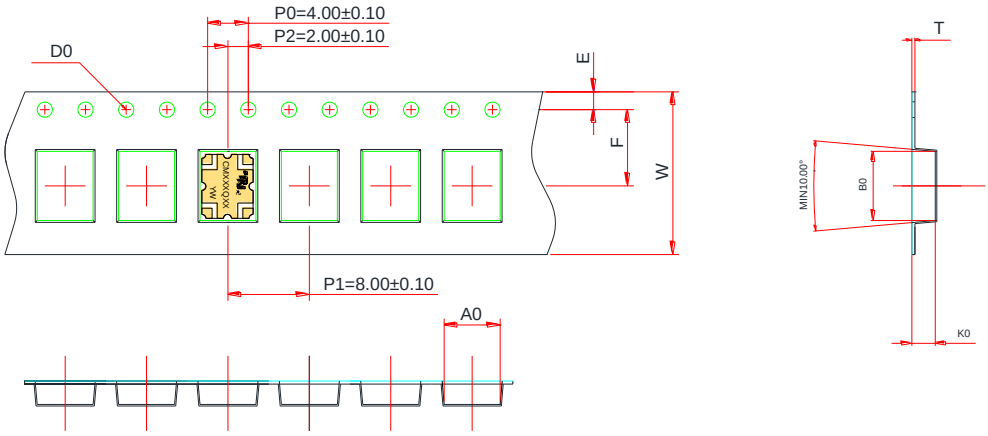

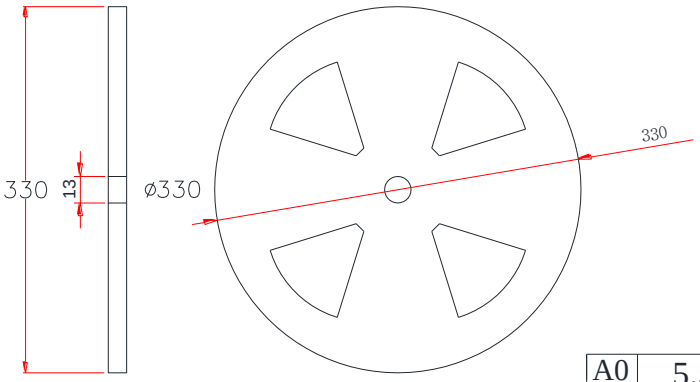

Unit : mm

A0	5.50±0.10	E	1.75±0.10
B0	6.80±0.10	F	7.50±0.10
D0	1.55±0.05	T	0.30±0.05
K0	1.87±0.10	W	16.00±0.30

Standard Packaging Quantity : 4,000 PCS / Reel

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CAUTION

PLEASE READ THIS NOTICE BEFORE USING OUR LTCC COUPLERS.

I. Be careful when transporting

- Ensure proper transportation as excessive stress or shock may damage LTCC couplers due to the nature of ceramics structure.
- LTCC couplers cracked or damaged on terminals may have their property changed.

II. Be careful during storage

- Store LTCC couplers less than temperature +30℃.
- Keep the humidity at 45% to 75% around LTCC couplers.
- Prevent corrosive gas (Cl_2, NH_3, SO_X, NO_X, etc.) from contacting LTCC couplers.
- It is recommended to use LTCC couplers within 6 months of receipt. If the period exceeds 6 months, solderability may need to be verified.

III. Be careful when soldering

- Solder all the ground terminals, IN and OUT pad of LTCC couplers on the ground plane of the PCB.
- LTCC couplers may be cracked or broken by uneven forces from a claw or suction device.
- Mechanical stress by any other devices may damage LTCC couplers when positioning them on PCB.
- Do not use dropped LTCC couplers.
- Ensure that any soldering is carried out by the condition of specification sheet.
- Do not re-use LTCC couplers which are de-soldered from PCB.

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